

General Description

The MDF13N50 uses advanced MagnaChip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

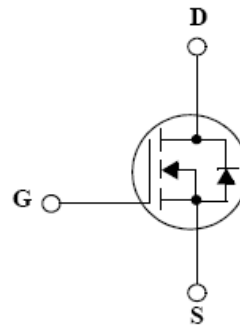
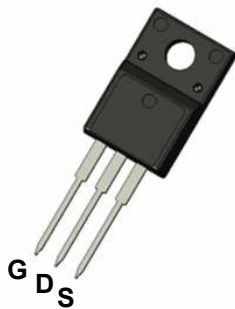
MDF13N50 is suitable device for SMPS, high Speed switching and general purpose applications.

Features

- $V_{DS} = 500V$
- $V_{DS} = 550V @ T_{jmax}$
- $I_D = 13.0A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 0.5\Omega$ @ $V_{GS} = 10V$

Applications

- Power Supply
- HID
- Lighting



Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit |
|--|---------------------|----------------------|---------|------|
| Drain-Source Voltage | | V_{DSS} | 500 | V |
| Drain-Source Voltage @ T_{jmax} | | $V_{DSS} @ T_{jmax}$ | 550 | V |
| Gate-Source Voltage | | V_{GSS} | ±30 | V |
| Continuous Drain Current (※) | $T_C = 25^\circ C$ | I_D | 13 | A |
| | $T_C = 100^\circ C$ | | 8.2 | A |
| Pulsed Drain Current ⁽¹⁾ | | I_{DM} | 52 | A |
| Power Dissipation | $T_C = 25^\circ C$ | P_D | 41 | W |
| | Derate above 25 °C | | 0.33 | W/°C |
| Peak Diode Recovery dv/dt ⁽³⁾ | | Dv/dt | 4.5 | V/ns |
| Single Pulse Avalanche Energy ⁽⁴⁾ | | E_{AS} | 580 | mJ |
| Junction and Storage Temperature Range | | T_J, T_{stg} | -55~150 | °C |

※ I_D limited by maximum junction temperature

Thermal Characteristics

| Characteristics | Symbol | Rating | Unit |
|--|-----------------|--------|------|
| Thermal Resistance, Junction-to-Ambient ⁽¹⁾ | $R_{\theta JA}$ | 62.5 | °C/W |
| Thermal Resistance, Junction-to-Case ⁽¹⁾ | $R_{\theta JC}$ | 3.05 | |

Ordering Information

| Part Number | Temp. Range | Package | Packing | RoHS Status |
|-------------|-------------|---------|---------|--------------|
| MDF13N50TH | -55~150°C | TO-220F | Tube | Halogen Free |

Electrical Characteristics (Ta =25°C)

| Characteristics | Symbol | Test Condition | Min | Typ | Max | Unit |
|--|--------------|--|-----|------|-----|----------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D = 250\mu A, V_{GS} = 0V$ | 500 | - | - | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 3.0 | - | 5.0 | |
| Drain Cut-Off Current | I_{DSS} | $V_{DS} = 500V, V_{GS} = 0V$ | - | - | 1 | μA |
| Gate Leakage Current | I_{GSS} | $V_{GS} = \pm 30V, V_{DS} = 0V$ | - | - | 100 | nA |
| Drain-Source ON Resistance | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 6.5A$ | | 0.39 | 0.5 | Ω |
| Forward Transconductance | g_{fs} | $V_{DS} = 40V, I_D = 6.5A$ | - | 13 | - | S |
| Dynamic Characteristics | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 400V, I_D = 13A, V_{GS} = 10V^{(3)}$ | - | 33 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 10.4 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 13 | - | |
| Input Capacitance | C_{iss} | $V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$ | - | 1390 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | - | 6.3 | | |
| Output Capacitance | C_{oss} | | - | 173 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{GS} = 10V, V_{DS} = 250V, I_D = 13A, R_G = 25\Omega^{(3)}$ | - | 30.2 | | ns |
| Rise Time | t_r | | - | 52.8 | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 60.8 | | |
| Fall Time | t_f | | - | 33.8 | | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Maximum Continuous Drain to Source Diode Forward Current | I_S | | - | 13 | - | A |
| Source-Drain Diode Forward Voltage | V_{SD} | $I_S = 13A, V_{GS} = 0V$ | - | | 1.4 | V |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 13A, di/dt = 100A/\mu s^{(3)}$ | - | 325 | | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 2.9 | | μC |

Note :

1. Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.
3. $I_{SD} \leq 9.0A$, $di/dt \leq 200A/\mu s$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$
4. $L = 6.2mH$, $I_{AS} = 13.0A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$

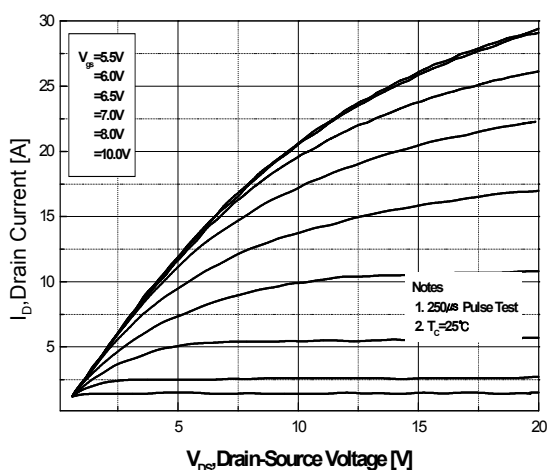


Fig.1 On-Region Characteristics

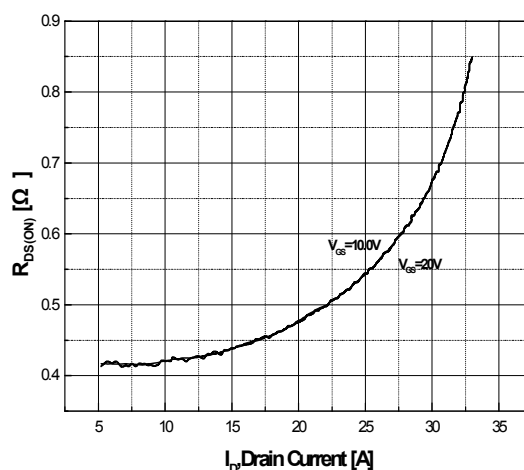


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

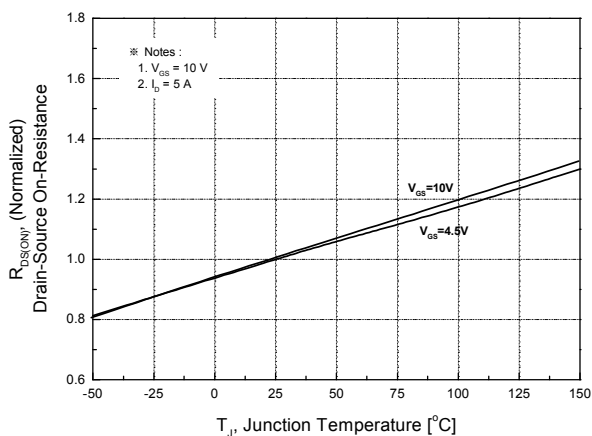


Fig.3 On-Resistance Variation with Temperature

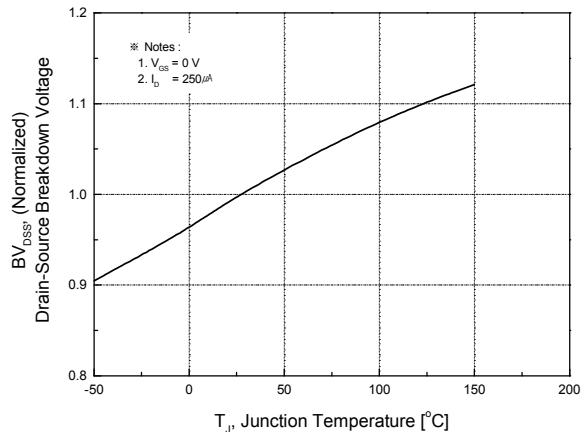


Fig.4 Breakdown Voltage Variation vs. Temperature

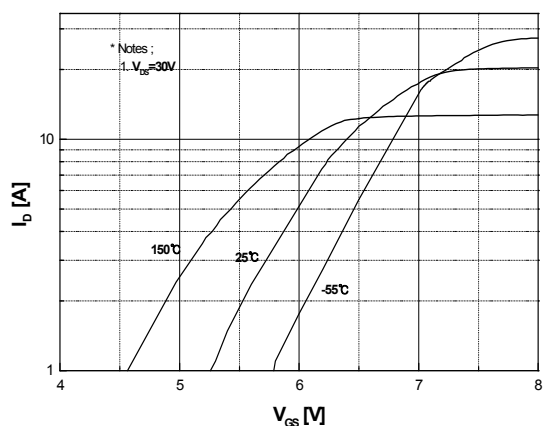


Fig.5 Transfer Characteristics

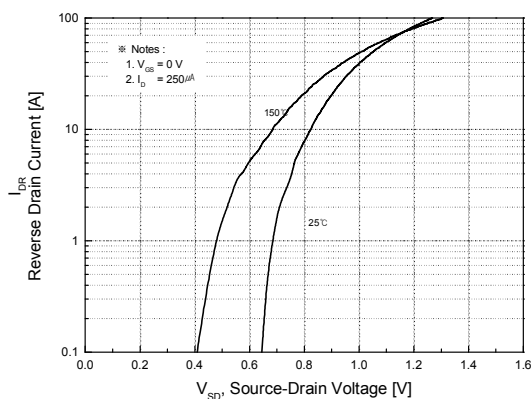
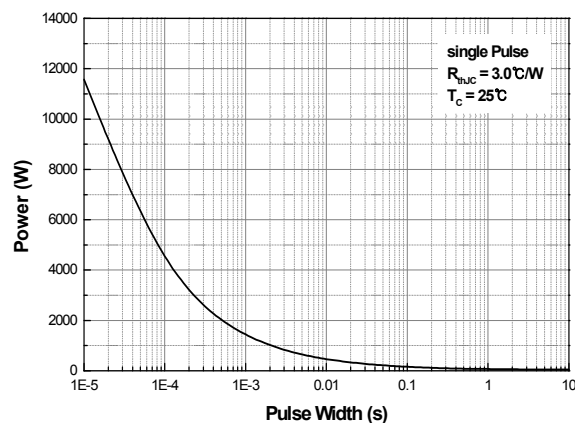
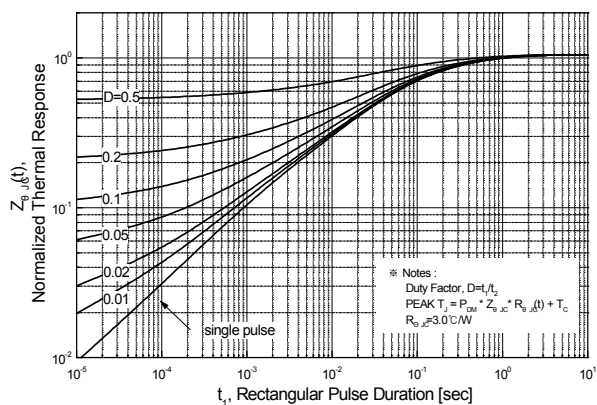
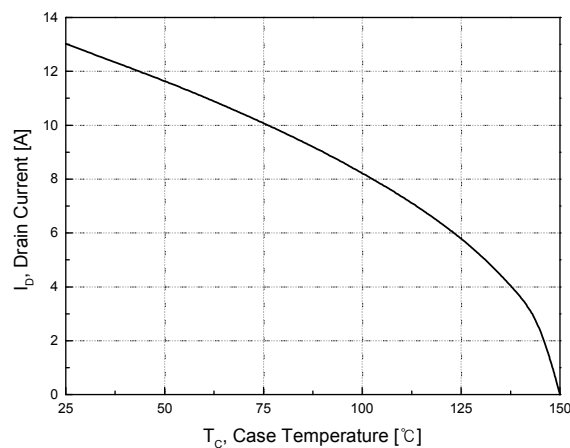
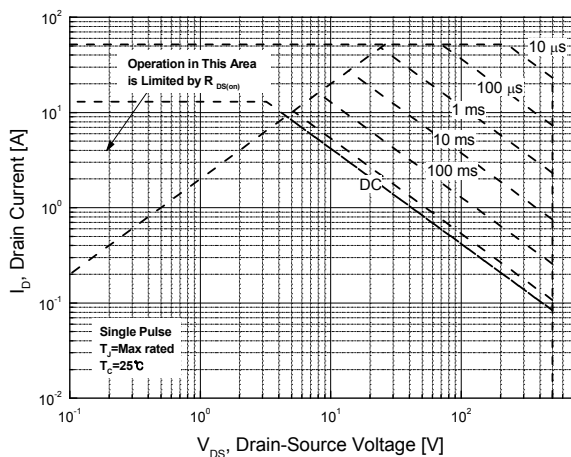
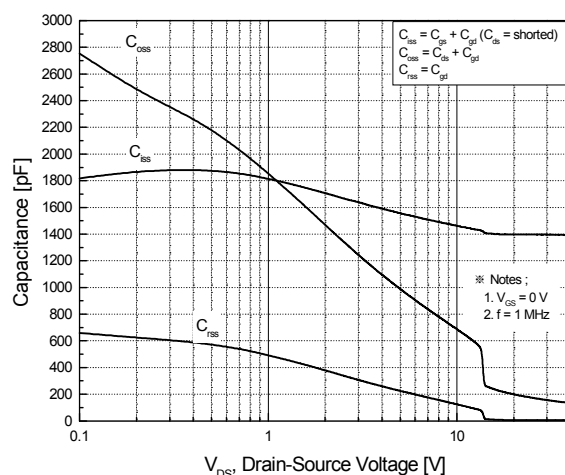
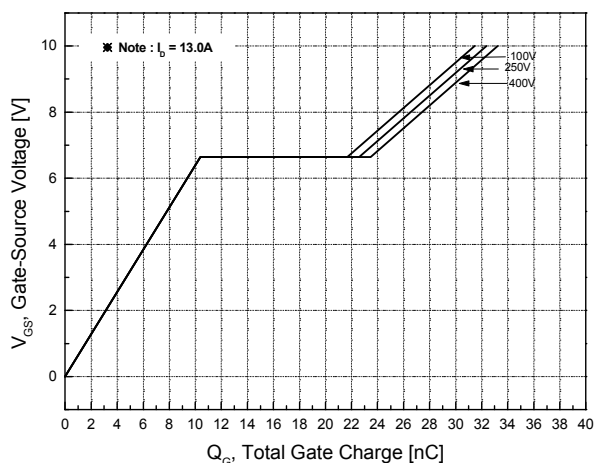


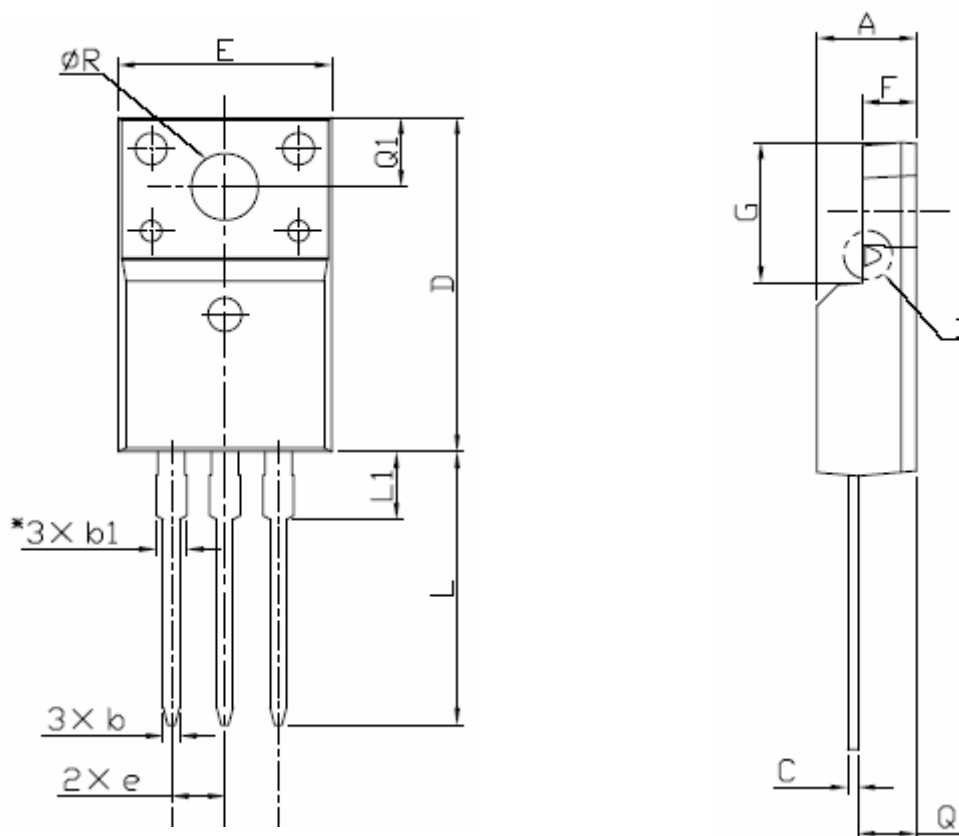
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature



Physical Dimensions

3 Leads, TO-220F

Dimensions are in millimeters unless otherwise specified



| Symbol | Min | Nom | Max |
|--------|-------|------|-------|
| A | 4.50 | | 4.93 |
| b | 0.63 | | 0.91 |
| b1 | 1.15 | | 1.47 |
| C | 0.33 | | 0.63 |
| D | 15.47 | | 16.13 |
| E | 9.60 | | 10.71 |
| e | | 2.54 | |
| F | 2.34 | | 2.84 |
| G | 6.48 | | 6.90 |
| L | 12.24 | | 13.72 |
| L1 | 2.79 | | 3.67 |
| Q | 2.52 | | 2.96 |
| Q1 | 3.10 | | 3.50 |
| Ø R | 3.00 | | 3.55 |

Worldwide Sales Support Locations

U.S.A

Sunnyvale Office

787 N. Mary Ave. Sunnyvale
CA 94085 U.S.A
Tel : 1-408-636-5200
Fax : 1-408-213-2450
E-Mail : usasales@magnachip.com

U.K

Knyvett House The Causeway,
Staines Middx, TW18 3BA, U.K.
Tel : +44 (0) 1784-895-000
Fax : +44 (0) 1784-895-115
E-Mail : uksales@magnachip.com

Japan

Osaka Office

3F, Shin-Osaka MT-2 Bldg 3-5-36
Miyahara Yodogawa-Ku
Osaka, 532-0003 Japan
Tel : 81-6-6394-9160
Fax : 81-6-6394-9150
E-Mail : osakasales@magnachip.com

Taiwan R.O.C

2F, No.61, Chowize Street, Nei Hu
Taipei, 114 Taiwan R.O.C
Tel : 886-2-2657-7898
Fax : 886-2-2657-8751
E-Mail : taiwansales@magnachip.com

China

Hong Kong Office

Suite 1024, Ocean Centre 5 Canton Road,
Tsim Sha Tsui Kowloon, Hong Kong
Tel : 852-2828-9700
Fax : 852-2802-8183
E-Mail : chinasales@magnachip.com

Shenzhen Office

Room 2003B, 20/F
International Chamber of Commerce Tower
Fuhua Road3 CBD, Futian District, China
Tel : 86-755-8831-5561
Fax : 86-755-8831-5565
E-Mail : chinasales@magnachip.com

Shanghai Office

Room E, 8/F, Liaoshen International Building 1068
Wuzhong Road, (C) 201103
Shanghai, China
Tel : 86-21-6405-1521
Fax : 86-21-6505-1523
E-Mail : chinasales@magnachip.com

Korea

891, Daechi-Dong, Kangnam-Gu
Seoul, 135-738 Korea
Tel : 82-2-6903-3451
Fax : 82-2-6903-3668 ~9
Email : koreasales@magnachip.com

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